

SID

Factory: Rot am See

Article:

ML6

Provided:

Customer:

Date:

03.04.2026

WÜRTH  
ELEKTRONIK  
MORE THAN  
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	1
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	320		2
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		3
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		4
		70	L2	
C-STD-FR4-ML-0.356mm-070+070-TG150-H...	50203122	356		5
		70	L3	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	214		6
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		7
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		8
		70	L4	
C-STD-FR4-ML-0.356mm-070+070-TG150-H...	50203122	356		9
		70	L5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	320		10
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		11
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		12
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	13

B00:

A01

A02

Thickness after Pressing

B00:

1890 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2090 µm

Dmin:

1690 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2000 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2200 µm

Dmin:

1800 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

1916 µm

Version 1.2.20.35

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